08-06-03

ey Docket No. 108298515US2

Disclosure No. 00-0999

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AUG 0 4 2003 E

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

N RE APPLICATION OF: WHONCHEE LEE ET AL.

APPLICATION No.: 09/887,767

FILED: JUNE 21, 2001

FOR: MICROELECTRONIC SUBSTRATE

HAVING CONDUCTIVE MATERIAL WITH BLUNT CORNERED APERTURES. AND

ASSOCIATED METHODS FOR

REMOVING CONDUCTIVE MATERIAL

EXAMINER: ALVIN J. GRAN

ART UNIT: 3723

CONF. No: 9072

Supplemental Information Disclosure Statement Within Three Months of Application Filing or Before First Action – 37 C.F.R. § 1.97(b)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

RECEIVED

AUG 1 1 2003

1. <u>Timing of Submission</u>

TECHNOLOGY CENTER H3700

This information disclosure is being filed within three months of the filing date of this application or date of entry into the national stage of an international application or before the mailing date of a first Office action on the merits, whichever occurs last [37 C.F.R. § 1.97(b)]. The references listed on the enclosed Form PTO-1449 (modified) may be material to the examination of this application; the Examiner is requested to make them of record in the application.

2. <u>Cited Information</u>

| | Copies of the following references are enclosed: | | |
|--|--|--|--|
| | | All cited references References marked by asterisks The following: | |
| | Copies of the following references can be found in parent U.S. Application No. : | | |
| | | All cited references References marked by asterisks The following: | |



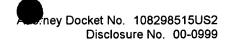
| × | under a com Autho be an for the the tra accur | The following references are not in English. For each such reference, the undersigned has enclosed (i) a translation of the reference; (ii) a copy of a communication from a foreign patent office or International Searching Authority citing the reference, (iii) a copy of a reference which appears to be an English-language counterpart, or (iv) an English-language abstract for the reference prepared by a third party. Applicant has not verified that the translation, English-language counterpart or third-party abstract is an accurate representation of the teachings of the non-English reference, though, and reserves the right to demonstrate otherwise. | | |
|---|---|--|--|--|
| | | All cited references References marked by ampersands The following: JP 2001077117 | | |
| Effect | of Info | rmation Disclosure Statement (37 C.F.R. § 1.97(h)) | | |
| that: exam result cited applic art to | (i) a sination s and tinformation the substitution (in a substitution). | tion Disclosure Statement is not to be construed as a representation search has been made; (ii) additional information material to the of this application does not exist; (iii) the information, protocols, he like reported by third parties are accurate or enabling; or (iv) the ation is, or is considered to be, material to patentability. In addition, es not admit that any enclosed item of information constitutes prior eject invention and specifically reserves the right to demonstrate that erence is not prior art. | | |
| Fee Payment | | | | |
| No fees are believed due because this Information Disclosure Statement is being filed before the mailing date of the first Office Action. | | | | |
| | | Applicant further submits that no fee is due in light of the following certification under 37 C.F.R. § 1.97(e) (check only one): | | |
| | | In accordance with 37 C.F.R. § 1.97(e)(1), the undersigned hereby states that each item of information submitted herewith was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement; or | | |
| | | In accordance with 37 C.F.R. § 1.97(e)(2), the undersigned hereby states that no item of information submitted herewith was cited in a communication from a foreign patent office in a counterpart foreign | | |

months prior to the filing of this statement.

application, or, to the knowledge of the person signing the certification after making reasonable inquiry, was known to any individual designated in 37 C.F.R. § 1.56(c), more than three

3.

4.



However, should the Commissioner determine that fees are due in order for this Information Disclosure Statement to be considered, the Commissioner is hereby authorized to charge such fees to Deposit Account No. 50-0665.

5. Patent Term Adjustment (37 C.F.R. § 1.704(d))

The undersigned states that each item of information submitted herewith was cited in a communication from a foreign patent office in a counterpart application and that this communication was not received by any individual designated in 37 C.F.R. § 1.56(c) more than thirty days prior to the filing of this statement. 37 C.F.R. § 1.704(d).

Respectfully submitted, Perkins Coie LLP

John M. Wechkin

Registration No. 42,216

Date: Aug 4, 2003

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